



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Features

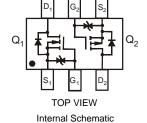
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- ESD Protected Up to 2.5kV
- "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 7
- Ordering Information: See Page 7
- Weight: 0.006 grams (approximate)







TOP VIEW

Maximum Ratings N-CHANNEL – Q_1 @ $T_A = 25$ °C unless otherwise specified

Characteri	stic		Symbol	Value	Unit
Drain Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±6	V
Drain Current (Note 1)	Steady State	T _A = 25°C T _A = 85°C	I _D	1066 690	mA

Maximum Ratings P-CHANNEL − Q₂ @T_A = 25°C unless otherwise specified

Characteri	stic		Symbol	Value	Unit
Drain Source Voltage			V_{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±6	V
Drain Current (Note 1)	Steady State	T _A = 25°C T _A = 85°C	I _D	845 548	mA

Thermal Characteristics – Total Device @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P _D	330	mW
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ hetaJA}$	379	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- . Device mounted on FR-4 PCB with minimum recommended pad layout.
- No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.



Electrical Characteristics N-CHANNEL – Q₁ @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)						•
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	Igss	-	-	±1.0	μΑ	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 4)						
Gate Threshold Voltage	V _{GS(th)}	0.5	-	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			0.3	0.45		$V_{GS} = 4.5V, I_D = 600mA$
Static Drain-Source On-Resistance	R _{DS (ON)}	-	0.4	0.6	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.5	0.75		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance	Y _{fs}	-	1.4	-	S	$V_{DS} = 10V, I_{D} = 400mA$
Diode Forward Voltage (Note 4)	V_{SD}		0.7	1.2	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 5)						
Input Capacitance	C _{iss}	-	60.67	-	pF	10 10 10 10 10 10 10 10 10 10 10 10 10 1
Output Capacitance	Coss	-	9.68	-	pF	$V_{DS} = 16V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	5.37	-	pF	1 = 1.000112
Total Gate Charge	Qg	-	736.6	-	рC	\\\\ 4.5\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Gate-Source Charge	Q_{gs}	-	93.6	-	рC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Q _{qd}	-	116.6	-	рС	$I_D = 250 \text{mA}$
Turn-On Delay Time	t _{D(on)}	-	5.1	-	ns	
Turn-On Rise Time	t _r	-	7.4	-	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(off)}	-	26.7	-	ns	$R_L = 47\Omega$, $R_G = 10\Omega$
Turn-Off Fall Time	t _f	-	12.3	-	ns	

Electrical Characteristics P-CHANNEL – Q₂ @T_A = 25°C unless otherwise specified

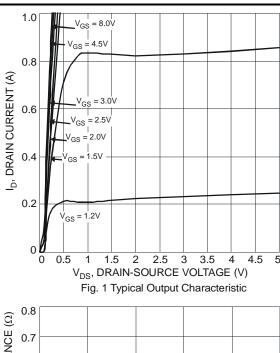
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)			-			
Drain-Source Breakdown Voltage	BV _{DSS}	-20	-	-	٧	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I_{GSS}	-	-	±2.0	μΑ	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 4)						
Gate Threshold Voltage	$V_{GS(th)}$	-0.5	-	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			0.5	0.75		$V_{GS} = -4.5V$, $I_D = -430mA$
Static Drain-Source On-Resistance	R _{DS} (ON)	-	0.7	1.05	Ω	$V_{GS} = -2.5V$, $I_D = -300$ mA
			1.0	1.5		$V_{GS} = -1.8V, I_D = -150mA$
Forward Transfer Admittance	Y _{fs}	1	0.9	1	S	$V_{DS} = -10V, I_{D} = -250mA$
Diode Forward Voltage (Note 4)	V_{SD}		-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$
DYNAMIC CHARACTERISTICS (Note 5)						
Input Capacitance	Ciss	-	59.76	-	pF	101/11/
Output Capacitance	Coss	-	12.07	-	pF	$V_{DS} = -16V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	6.36	ı	pF	1 – 1.0101112
Total Gate Charge	Q_g	-	622.4	-	рC	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Gate-Source Charge	Q_{gs}	-	100.3	-	рC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_{D} = -250$ mA
Gate-Drain Charge	Q_{gd}	-	132.2	-	рC	1D = -23011A
Turn-On Delay Time	t _{D(on)}	-	5.1	-	ns	
Turn-On Rise Time	t _r	-	8.1	-	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}	-	28.4	-	ns	$R_L = 47\Omega$, $R_G = 10\Omega$
Turn-Off Fall Time	t _f	-	20.7	-	ns	

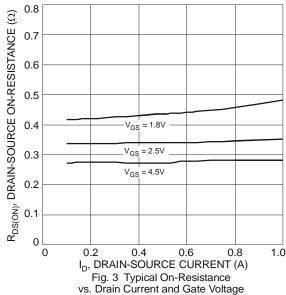
Notes:

- 4. Short duration pulse test used to minimize self-heating effect.
- 5. Guaranteed by design. Not subject to production testing.



N-CHANNEL - Q₁





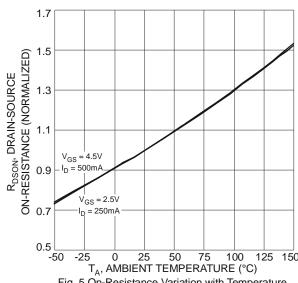
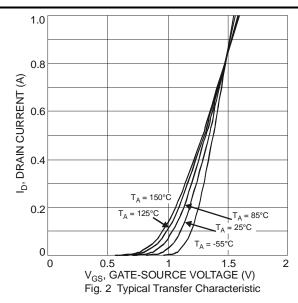
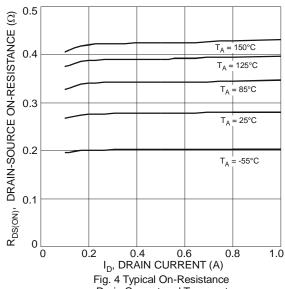
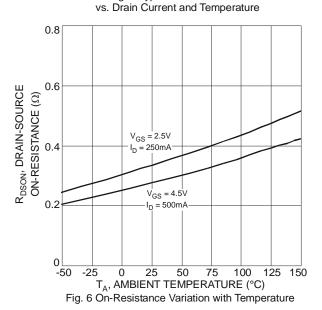


Fig. 5 On-Resistance Variation with Temperature









N-CHANNEL - Q₁ (continued)

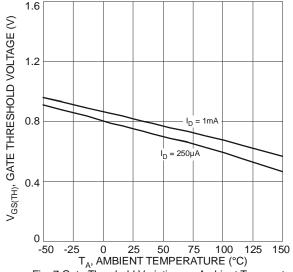
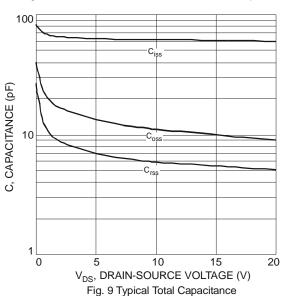
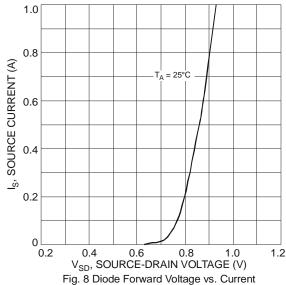


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





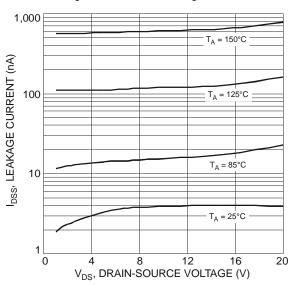


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

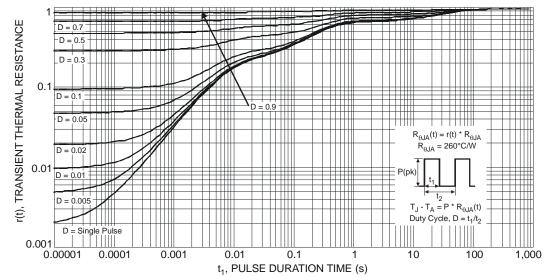
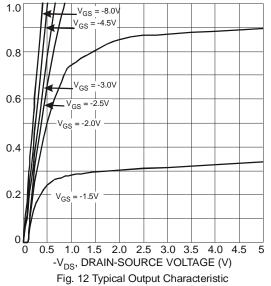
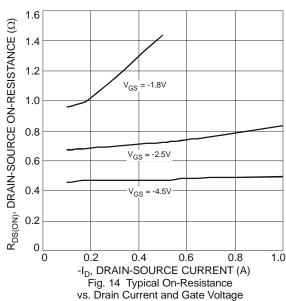


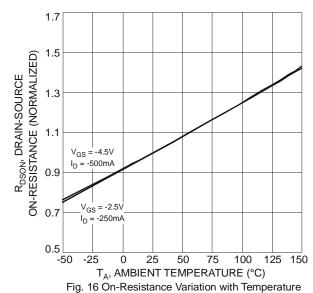
Fig. 11 Transient Thermal Response



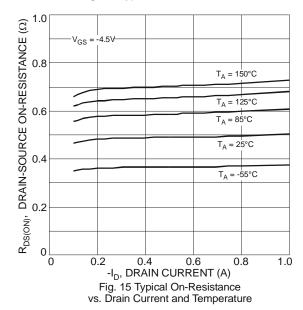
P-CHANNEL - Q₂

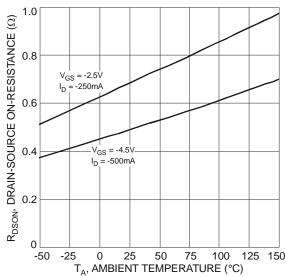






1.0 $V_{DS} = -5V$ 0.8 -I_D, DRAIN CURRENT (A) 0.2 T_A = 85°C = 25°C -55°C 0 0 1.0 1.5 2.0 3.0 -V_{GS}, GATE-SOURCE VOLTAGE (V) Fig. 13 Typical Transfer Characteristic



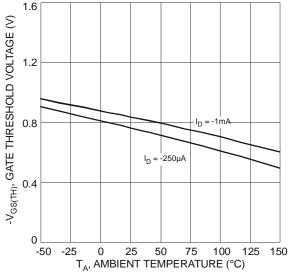


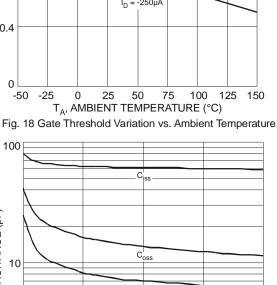
C, CAPACITANCE (pF)

0

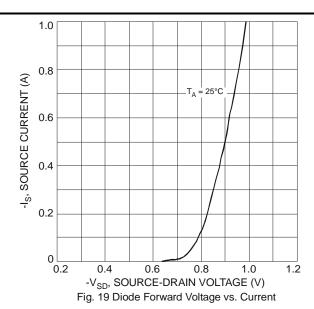


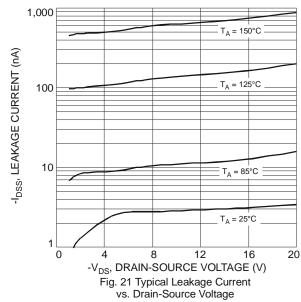
P-CHANNEL - Q₂ (continued)

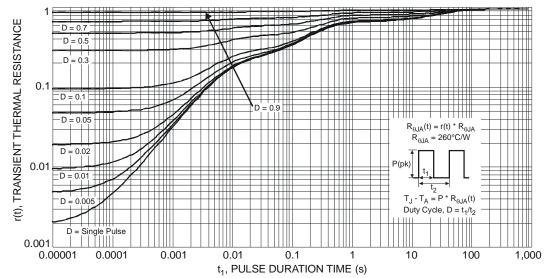




5 10 15 -V_{DS}, DRAIN-SOURCE VOLTAGE (V) Fig. 20 Typical Total Capacitance







20

Fig. 22 Transient Thermal Response

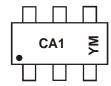


Ordering Information (Note 6)

Part Number	Case	Packaging
DMG1016UDW-7	SOT-363	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

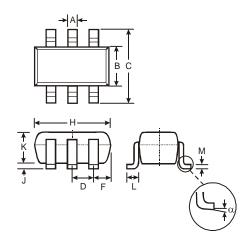


CA1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)

Date Code Key

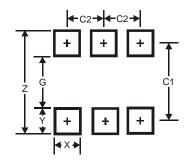
Year	2009	9	2010		2011	20	12	2013		2014	2	2015
Code	W		Χ		Υ	Ž	7	Α		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Package Outline Dimensions



SOT-363						
Dim	Min	Max				
Α	0.10	0.30				
В	1.15	1.35				
С	2.00	2.20				
D	0.65	Тур				
F	0.40	0.45				
Н	1.80	2.20				
J	0	0.10				
K	0.90	1.00				
L	0.25	0.40				
М	0.10	0.22				
α	0°	8°				
All Di	mensions	in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Υ	0.6
C1	1.9
C2	0.65



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